

Gels *Dow Corning*[®] 3-6371 UV Gel

1-part, very soft, translucent, UV cure, low temperature gel

FEATURES

- 1-part UV cure with moisture secondary cure
- Requires no mixing
- Suitable for very low temperatures

BENEFITS

- No mixing required
- UV cureable for extremely fast processing speeds
- Moisture secondary cure for shadowed areas
- Gel remains flexible in very low temperature applications

TYPICAL PROPERTIES

Specification Writers: Please contact your local Dow Corning sales office or your Global Dow Corning Connection before writing specifications on this product.

Property	Unit	Value
Viscosity	cP	900
	mPa-sec	900
	Pa-sec	0.9
Specific Gravity (Uncured)	-	0.98
Gel Hardness	grams	40
Penetration	1/10 mm	140
UV Cure Time (to 90% Gel Hardness)	Seconds	25
Dielectric Strength	volts/mil	300
	kV/mm	12
Dielectric Constant at 100 Hz	-	2.81
Dielectric Constant at 100 kHz	-	2.81
Volume Resistivity	ohm*cm	1.9E12
Dissipation Factor at 100 hz	-	0.0047
Dissipation Factor at 100 kHz	-	0.00006
Shelf Life at 25°C	months	12

DESCRIPTION

This group of gels addresses special needs to enable your designs in a reliable and cost effective manner. This family include thixotropic gels that provide controlled flow, fluorogels with resistance to some solvents and fuels, controlled volatility gels for sensitive applications, and uv curing gels for very fast and low temperature cure. Gels are a special class of encapsulants that cure to an extremely soft material. Gels cure in place to form cushioning, self-healing, resilient materials. Cured gels retain much of the stress relief and self-healing qualities of a liquid while providing the dimensional stability of an elastomer which is increasingly needed for delicate components. Gels have been used to isolate circuits from the harmful effects of moisture and other contaminants and provide electrical insulation for high voltages. Another use is providing stress relief to protect circuits and interconnections from thermal and mechanical stresses. Gels are usually applied in thick layers to totally encapsulate higher architectures. More recently, gels have found application in optoelectronics due to their stress relieving capability and high refractive index, as well as the stability of these properties over time.

MIXING AND DE-AIRING

Some gels are supplied in bladder packs that avoid direct air contact with the liquid gel components, allowing use of air pressure over the pack in a pressure pot for dispensing. Do not apply air pressure directly to the liquid gel surface (without the bladder pack) as the gel can become supersaturated with air and bubbling can occur when the material is dispensed and cured. Use of bladder packs prevents bubbling, maintains cleanliness and avoids gel contamination. Gels can be dispensed manually or by using one of the available types of meter mix equipment. If possible, the potential for entrapment and incorporation of gas (typically air) should be considered during design of the part

and selection of a process to dispense the gel. This is especially important with higher-viscosity and faster-curing gels. Degassing at >28 inches (10-20 mm) Hg vacuum may be necessary to ensure a void-free, protective layer.

USEFUL TEMPERATURE RANGES

For most uses, silicone elastomers should be operational over a temperature range of -45 to 200°C (-49 to 392°F) for long periods of time. However, at both the low- and high temperature ends of the spectrum, behavior of the materials and performance in particular applications can become more complex and require additional considerations. For low-temperature performance, thermal cycling to conditions such as -55°C (-67°F) may be possible, but performance should be verified for your parts or assemblies. Factors that may influence performance are configuration and stress sensitivity of components, cooling rates and hold times, and prior temperature history. At the high-temperature end, the durability of the cured silicone elastomer is time and temperature dependent. As expected, the higher the temperature, the shorter the time the material will remain useable.

COMPATIBILITY

Certain materials, chemicals, curing agents and plasticizers can inhibit the cure of addition cure adhesives. Most notable of these include: Organotin and other organometallic compounds, Silicone rubber containing organotin catalyst, Sulfur, polysulfides, polysulfones or other sulfur containing materials, unsaturated hydrocarbon plasticizers, and some solder flux residues. If a substrate or material is questionable with respect to potentially causing inhibition of cure, it is recommended that a small scale compatibility test be run to ascertain suitability in a given application. The presence of liquid or uncured product at the interface between the questionable substrate

and the cured gel indicates incompatibility and inhibition of cure.

REPAIRABILITY

In the manufacture of electronic devices, salvage or rework of damaged or defective units is often required. Removal of Dow Corning dielectric gels to allow necessary repairs can be assisted by using Dow Corning® OS Fluids. Additional information regarding these products is available from Dow Corning. Digestive stripping agents, such as SU100 from Silicones Unlimited, can also be used. In addition, if only one component needs to be replaced, a soldering iron may be applied directly through the gel to remove the component. After work has been completed, the repaired area should be cleaned with forced air or a brush, dried, and patched with additional silicone gel.

PACKAGING

In general, Dow Corning dielectric gels are available in batch-matched kits containing both Part A and Part B components. Packages that are typically available include 210-mL dual cartridges, one-gallon pails, five-gallon pails and 55-gallon drums. Not all gels may be available in all packages, and some additional packages and package sizes may be available.

STORAGE AND SHELF LIFE

Storage conditions and shelf life ("Use By" date) are indicated on the product label.

HEALTH AND ENVIRONMENTAL INFORMATION

To support customers in their product safety needs, Dow Corning has an extensive Product Stewardship organization and a team of Product Safety and Regulatory Compliance (PS&RC) specialists available in each area. For further information, please see our website, www.dowcorning.com, or consult

your local Dow Corning representative.

LIMITATIONS

These products are neither tested nor represented as suitable for medical or pharmaceutical uses.

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